

1.0 Products

1.1 Wafer Inspection Products

1.1.1 Autowafer Pro™: Ultrasonic Equipment for NDT of Bonded Wafers

1.1.2 Autowafer™: Automatic Ultrasonic Testing for Bonded Wafers

1.1.3 Wafer Software Options for AutoWafer and AutoWafer Pro

1.1.4 Transducers for AutoWafer and AutoWafer Pro

1.1.5 NEW pulse2 Pulser/Receiver for all ECHO and AutoWafer Systems
(This was not on Ryan's matrix)

1.2 Semiconductor Package Inspection Products

1.2.1 ECHO VS™ Ultrasonic NDT Equipment

1.2.2 ECHO™ Ultrasonic Flaw Detector

1.2.3 Software Options for Sonix ECHO, ECHO VS and ECHO Pro

1.2.4 Transducers for Sonix ECHO, ECHO VS and ECHO Pro

Utility Navigation

Contact Us

Request Quote

Find Support

Language Sites

Header Navigation

Sonix logotype (Home)

Products

Applications

Resources

About

2.0 Applications

2.1 Wafer Inspection Applications

2.1.1 Bonded Wafer Inspection

2.1.2 Microelectromechanical Systems - MEMS Inspection

2.1.3 LED Inspection

2.1.4 Through-Silicon Vias - TSV Inspection

2.1.5 Backside Illuminated (BSI) Sensor Inspection

2.2 Semiconductor Package Inspection Applications

2.2.1 Molded Underfill (MUF) Inspection

2.2.2 Stacked Die Imaging (SDI)

2.2.3 Flip Chip Inspection

2.2.4 Wafer Chip Scale Package (CSP) Inspection

2.2.5 Ball Grid Arrays

2.2.6 Plastic-Encapsulated IC Inspection

2.2.7 Hybrid and Multi-Chip Module (MCM) Package Inspection

Footer Navigation

Sonix logotype (Home)

Products

Applications

Resources

About

Custom Email (Form)

Request a Sample Analysis (Form)

Connect with Us (Form)

Privacy Notice - Accessibility Statement - Terms of Use - Disclaimer

*Industrial Applications is a landing page that is accessed through the applications category page.

3.1 Industrial Applications*

IGBT (Need full name)

LED (wafer/packages)

Composites

3.0.1 Gold Club Heads

3.0.2 Carbon Materials

High voltage electrical contacts - Schneider

3.0.3 Copper contact delam - PGE

Precious Metals

Coatings

Inkjet heads

Modine - HVAC heat sink

Bone cross sections

Lithium-ion batteries - batteries

Solar devices/panels

Silicone ingots

Optic lenses

Pacemakers

Dental implants

4.0 Resources

4.1 FAQs (4-6 Common Support Questions)

4.1.1 Package FAQs

4.1.2 Wafer FAQs

Cross-Linked w/ Solutions

4.2 Specification Sheets

Cross-Linked w/ FAQs

4.3 Video Tutorials

4.4.1 Publications & News

4.4 White Papers

5.0 About

5.1 The Sonix Story

5.1.1 History & Innovation

5.2 Sonix Difference

5.2.1 Solutions & Record

5.4 Partnerships

Opportunities & Successes

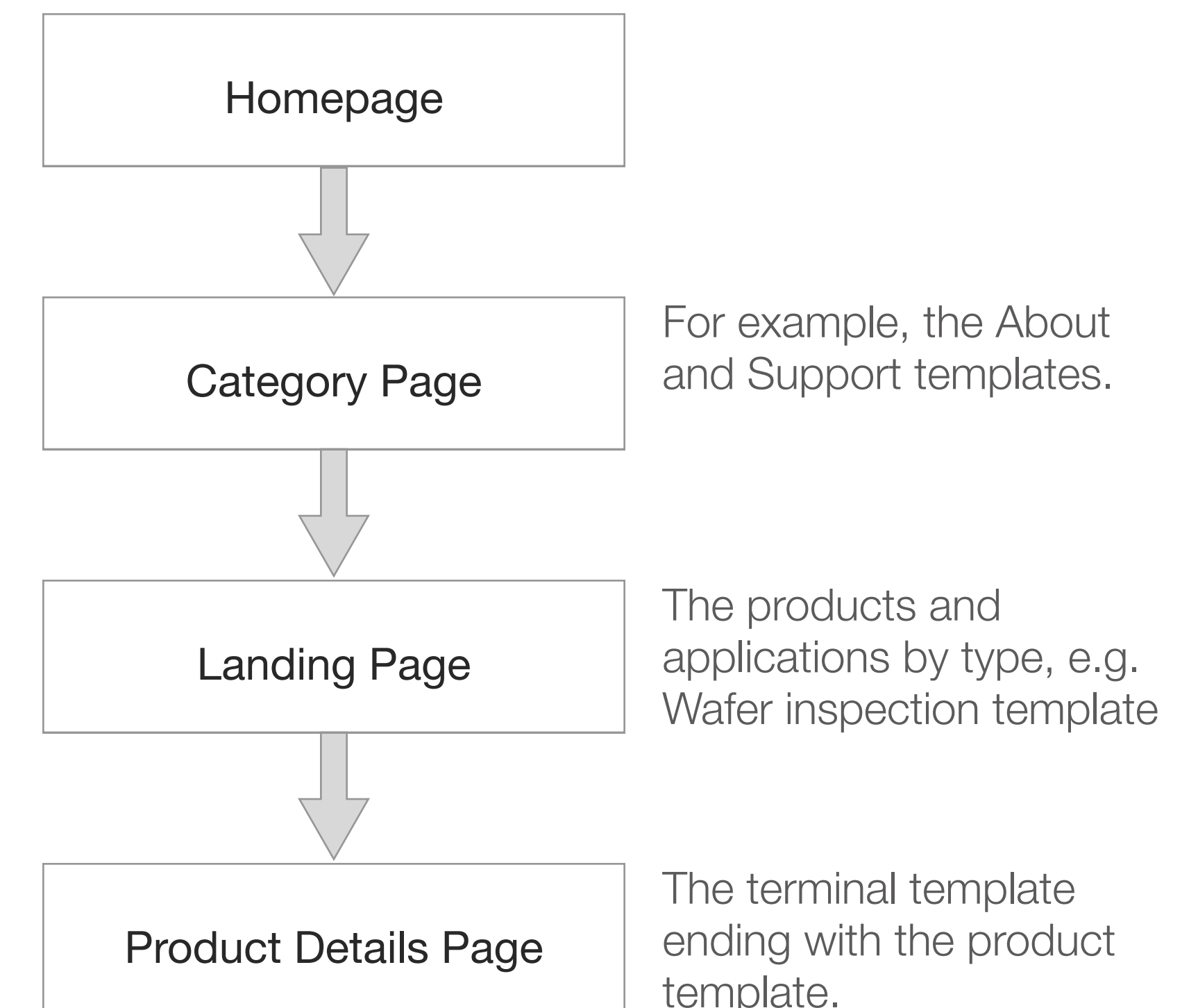
5.5 Tektronics

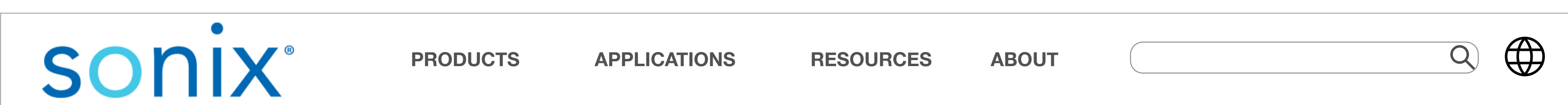
5.5.1 Fortive Relations & Brand

5.6 Contact Us

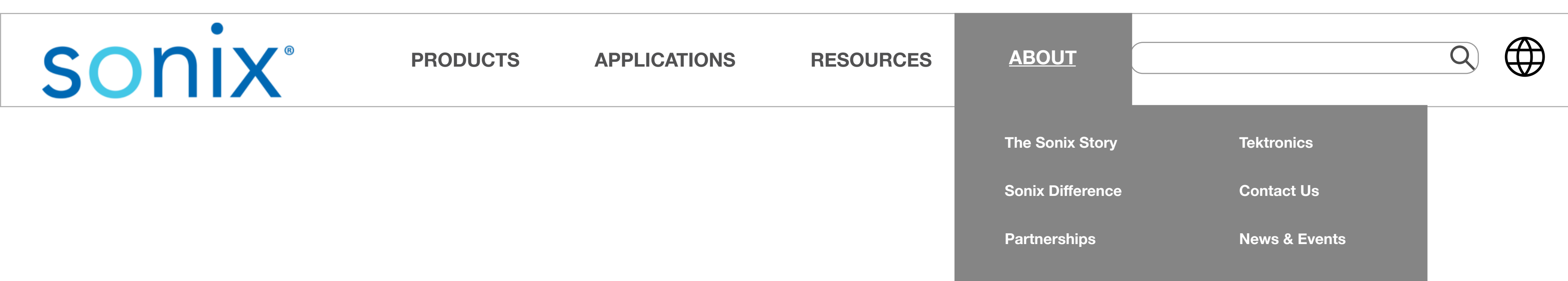
Form successfully submitted

5.7 News & Events



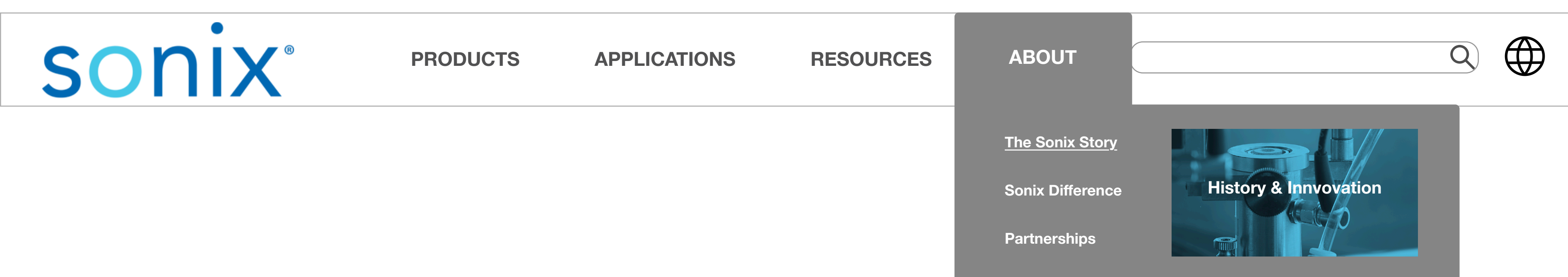


The complete global navigation, featuring the utility navigation, logotypem and three main categories, and search.

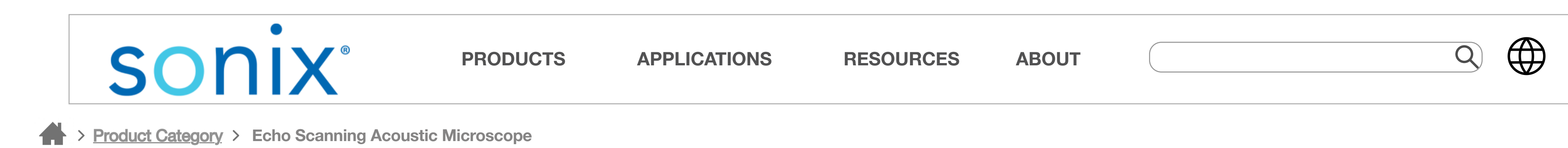


The fly-out navigation will function as a series of panels allowing users to drill down to the product details template level.

State 1. The end-user clicks on the category link and the fly-out navigation appears revealing the landing pages for the selected category.



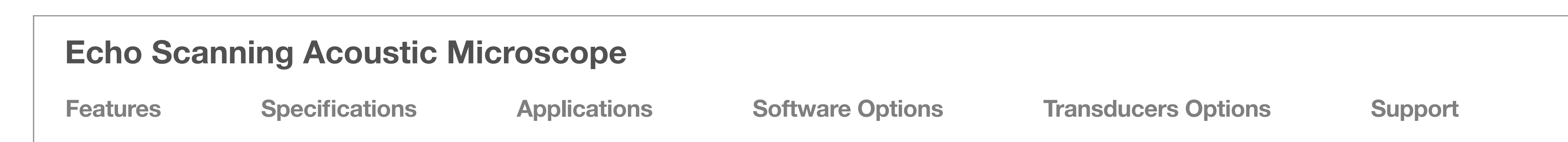
State 2. The end-user clicks on the landing page template link and the fly-out navigation appears revealing the product details template



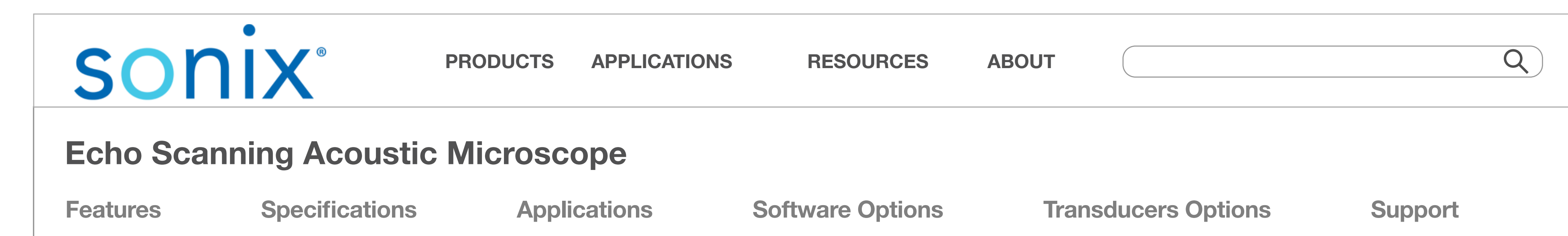
Once end-users begin to drill down in the architecture a breadcrumb navigation will be available for navigation..



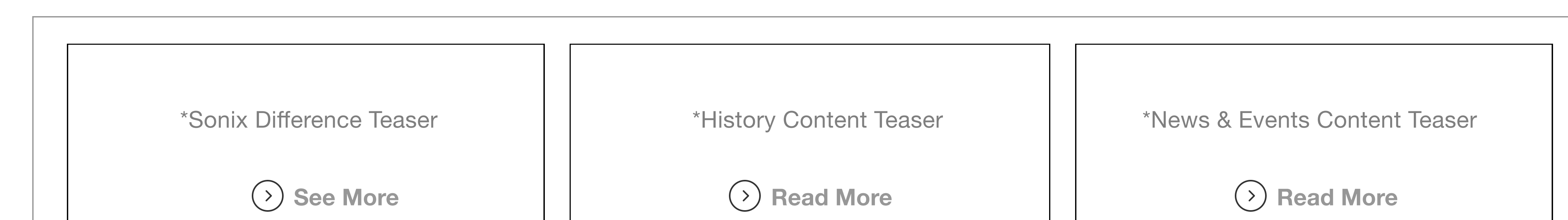
The global navigation sans utility navigation will be sticky and tacked to the top of the browser window as the user scrolls down the page.



On the product details page, the sub-navigation for the product information stripes will also be sticky and activate as such when the user scrolls past it.



The global navigation and sub-navigation will both be tacked to the top of the browser chrome as seen here. Special consideration should be given in the design phase to minimize the overall height of both navigational elements.



The global footer is comprised of the three-column teasers (Sonix Difference, Sonix History, and News & events) and the logotype, address, and the main categories and their r respective subcategories, and finally the connect with us CTA.

This global footer and its components should be used throughout the Sonix website.



MEMS, Bonded Wafers, and Packaged Semiconductor Inspections

Verify that the products you send to market are free of welding, brazing or adhesive voids. Sonix provides a clear view into the bonded interface for electrical contacts, drill-bit abrasives and other industrial applications.

[See How It Works](#)

Product Category Img

Product Category Img

Product Category Img

Wafer Inspection

Voluptate velit esse cillum dolore est fugiat nulla cest pariatur. Expteurres sint occaecat cupidatat non sunt in culpa qui.

[Details](#)

Package Inspections

Selit esse cillum dolore est fugiat nulla cest pariatur. Expteurres sint occaecat cupidatat non sunt inqui.

[Details](#)

Industrial Inspection

Esse cillum dolore est fugiat nulla cest pariatur. Expteurres sint occaecat cupidatat non sunt in culpa qui.

[Details](#)

*Sonix Difference Teaser

[See More](#)

*History Content Teaser

[Read More](#)

*News & Events Content Teaser

[Read More](#)

Interchangeable hero imagery featuring the latest product highlights and/or processes with a large CTA. Using industry-related vocabulary along with descriptive text should help boost SEO and reduce the number of erroneous users.

Featured Product categories. Clicking on a category will take the user to a category page where they may peruse products by category.

These three boxes are meant to quickly highlight unique and powerful product and application features. They could also be utilized for news and product enhancements.

*optional for launch

MEMS inspection

Lorem ipsum dolor sit amet, consectetur adipiscing elit, sed do eiusmod tempor est incididunt ut labore et dolore magna aliqua. Ut enim ad minim veniam, quis nostrud exercitation ullamco laboris nisi ut aliquip ex ea commodo consequat.

Lorem ipsum dolor sit amet, consectetur adipiscing elit, sed do eiusmod tempor est incididunt ut labore et dolore magna aliqua. Ut enim ad minim veniam, quis nostrud exercitation ullamco laboris nisi ut aliquip ex ea commodo consequat. Incidunt ut labore et dolore magna aliqua.

[Read More](#)

Application Related Imagery

Application Related Imagery

Featured Application: A case study-like presentation of an application process with supporting text and imagery. Clicking on the link will take a user to the application details page.

Product Resources

Lorem ipsum dolor sit amet, consectetur adipiscing elit, sed do eiusmod tempor est incididunt ut labore et dolore magna aliqua. Ut enim ad minim veniam, quis nostrud exercitation ullamco laboris nisi ut aliquip.

FAQs Imagery

Common FAQs

Lorem ipsum dolor sit amet, con est sectetur adipiscing elit, sed dolomer eiusmod tempor est incididunt. Voluptate velit esse cillum est.

Manual Imagery

Product Resources

Lorem ipsum dolor sit amet, con est sectetur adipiscing elit, sed dolomer eiusmod tempor est incididunt. Voluptate velit esse cillum est.

Technical Papers Imagery

Technical Papers

Lorem ipsum dolor sit amet, con est sectetur adipiscing elit, sed dolomer eiusmod tempor est incididunt. Voluptate velit esse cillum est.

[See All Resources](#)

Resource types. A mix of currently available resource types available on the website. Each link will go to the corresponding resource under the Resource section and clicking on the See All Resources will go to a Resources category page.

Request a Custom Quote

Custom Quote Imagery

Lorem ipsum dolor sit amet, consectetur adipiscing elit, sed do eiusmod tempor est incididunt ut labore et dolore magna aliqua. Ut enim ad minim veniam, quis nostrud exercitation ullamco laboris nisi ut aliquip.

[Request a Quote](#)

Request a custom quote CTA will feature imagery, instructional text, and a button to the form.

Clicking on the globe icon will reveal a country pulldown menu

Select a country ▼

New Imagery TBD

See How It Works

Product Category Img

Product Category Img

Product Category Img

Wafer Inspection

Voluptate velit esse cillum dolore est fugiat nulla cest pariatur. Expteurres sint occaecat cupidatat non sunt in culpa qui.

> Details

Package Inspections

Selit esse cillum dolore est fugiat nulla cest pariatur. Expteurres sint occaecat cupidatat non sunt inqui.

> Details

Industrial Inspection

Esse cillum dolore est fugiat nulla cest pariatur. Expteurres sint occaecat cupidatat non sunt in culpa qui.

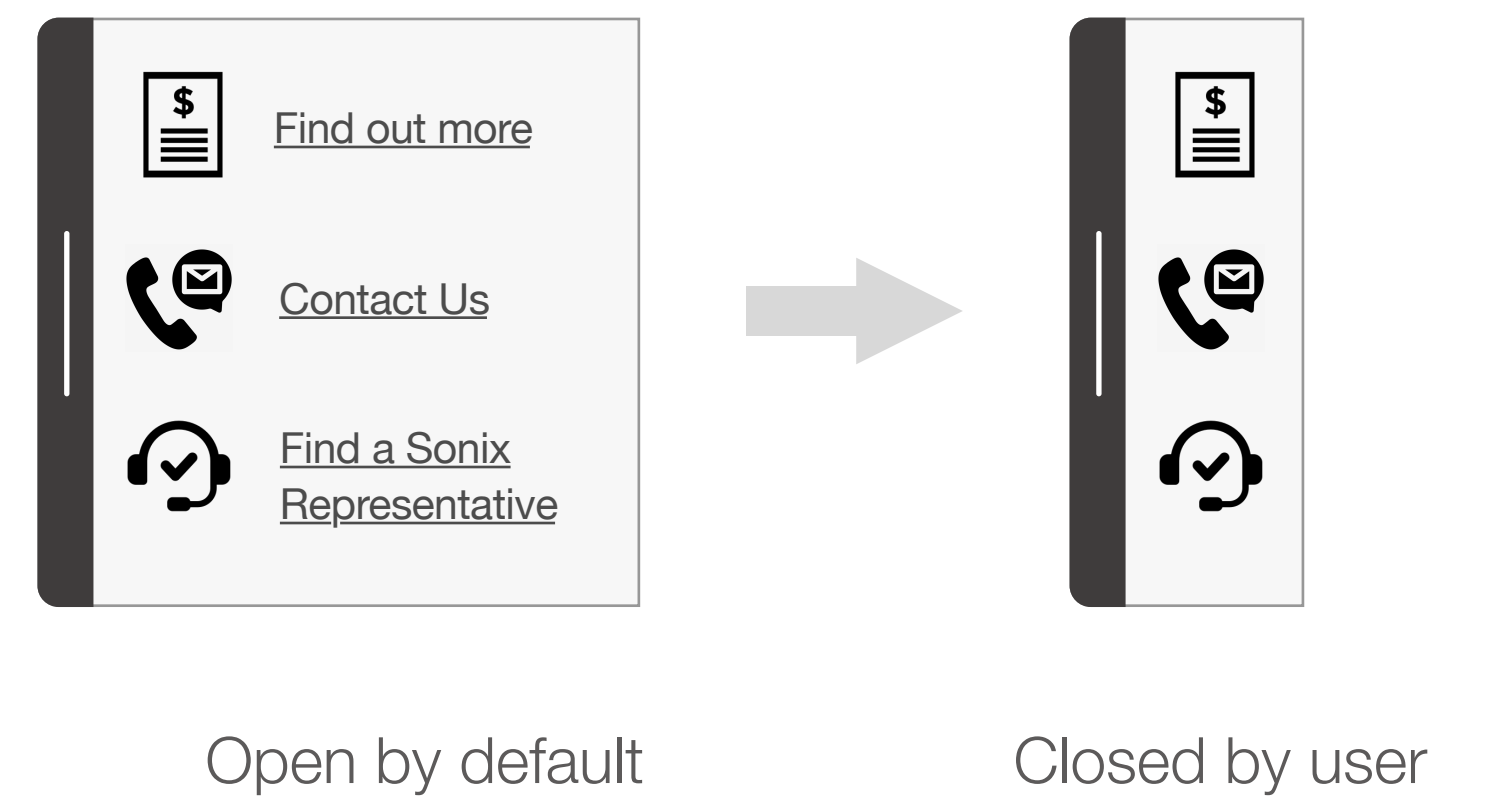
> Details

- [Find out more](#)
- [Contact Us](#)
- [Find a Sonix Representative](#)

Hero imagery featuring the latest product highlights and/or processes within a large CTA. Using industry-related vocabulary along with descriptive text should help boost SEO and reduce the number of erroneous users.

Featured Product categories. Clicking on a category will take the user to a category page where they may peruse products by category.

The new utility navigation will be sticky and accompany the user as they scroll down the each page. The destinations points of each link within have not changed.



1. Find out more: Find out more form on the contact us page
2. Contact Us page: Default
3. Find a Representative: Present overlay

Featured Application: A case study-like presentation of an application process with supporting text and imagery. Clicking on the link will take a user to the application details page.

Wafer inspection

Lorem ipsum dolor sit amet, consectetur adipiscing elit, sed do eiusmod tempor est incididunt ut labore et dolore magna aliqua. Ut enim ad minim veniam, quis nostrud exercitation ullamco laboris nisi ut aliquip ex ea commodo consequat.

Lorem ipsum dolor sit amet, consectetur adipiscing elit, sed do eiusmod tempor est incididunt ut labore et dolore magna aliqua. Ut enim ad minim veniam, quis nostrud exercitation ullamco laboris nisi ut aliquip ex ea commodo consequat. Incidunt ut labore et dolore magna aliqua.

Read More

Application Related Imagery

Application Related Imagery

*Sonix Difference Teaser

> See More

*History Content Teaser

> Read More

*News & Events Content Teaser

> Read More

The mega footer incorporates the top level categories and an assortment respective landing pages.

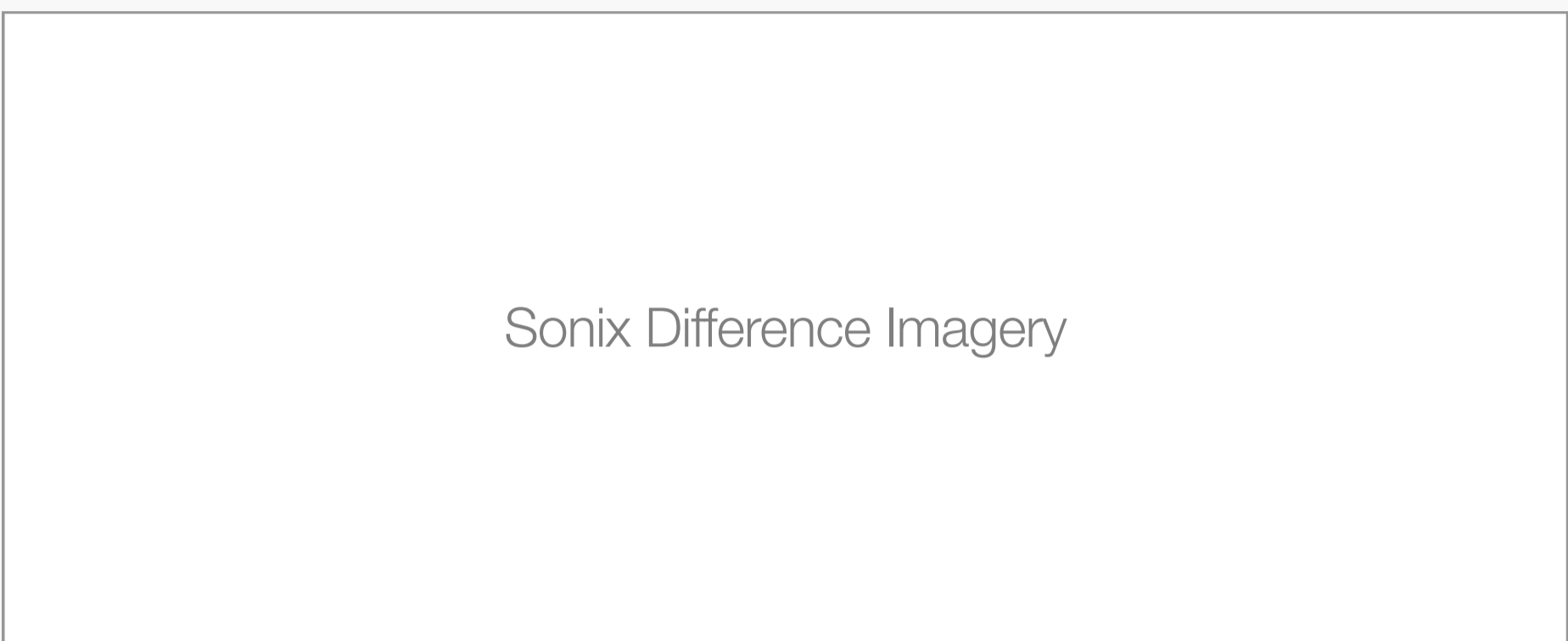
In addition, a bold and friendly contact us CTA will drive users to the contact us page with the the multi-form.

Where others have failed, we have consistently found the right answers to very difficult problems.

Today, Sonix acoustic scanning microscopes are used by leading manufacturers worldwide to perform nondestructive inspection of bonded wafers and packaged semiconductors, from the development lab to the production floor.

<p>Lorem ipsum dolor sit amet, con est</p> <p>➤ See More</p>	<p>Lorem ipsum dolor sit amet, con est</p> <p>➤ Read More</p>	<p>Lorem ipsum dolor sit amet, con est</p> <p>➤ Read More</p>
--	---	---

Sonix difference amet, consectetur adipiscing elit, sed do eiusmod tempor est incididunt ut labore et dolore magna aliqua. Ut enim ad minim veniam, quis nostrud exercitation ullamco laboris nisi ut aliquip ex ea commodo consequat. Incidunt ut labore et dolore magna aliqua.



See How

About & Value Proposition

Sonix Difference

Global Presence cativity adipiscing elit, sed do eiusmod est tempor este incididunt ut labore est dolores magna aliqua.

Technology History	Sonix Story	Parent Company (Tektronix?)
--------------------	-------------	-----------------------------

Lorem ipsum dolor sit amet, consectetur adipiscing elit, sed do eiusmod est tempor est incididunt ut labore et dolore magna aliqua. Ut enim ad minim veniam, quis nostrud exercitation ullamco

Est lorem ipsum dolor sit amet, consectetur adipiscing elit, sed do eiusmod est tempor est incididunt ut labore et dolore magna aliqua. Ut enim ad minim veniam, quis nostrud exercitation ullamco

Klora ipsum dolor sit amet, consectetur adipiscing elit, sed do eiusmod est tempor est incididunt ut labore et dolore magna aliqua. Ut enim ad minim veniam, quis nostrud exercitation ullamco

Lear about our History

The Sonix Story

Learn about Tektronix ↗

History & Sonix CTA

Introducing the three main Sonix themes from a historical perspective:

1. Technology History: Product Category Page
2. Sonix Story: About Category Page
3. Tektronix Homepage

News & Events Img	News & Events Img	News Video 1	News Video 2
-------------------	-------------------	--------------	--------------

News & Events Article 1

Voluptate velit esse cillum dolore est fugiat nulla cest pariatur. Expteurres sint occaecat cupidatat non sunt in culpa qui.

News & Events Article 2

Selit esse cillum dolore est fugiat nulla cest pariatur. Expteurres sint occaecat cupidatat non sunt in qui.

News Video 1

Esse cillum dolore est fugiat nulla cest pariatur. Expteurres sint occaecat

News Video 2

Esse cillum dolore est fugiat nulla cest pariatur. Expteurres sint occaecat cupidatat non sunt qui.

New & Events Section

Featuring mixed media formats opf newsworthy items, including articles, news features, events, and videos.

Specifications	Videos	Manuals
----------------	--------	---------

Sed do eiusmod est tempor est incididunt ut labore et dolore magna aliqua. Ut enim ad minim veniam, quis nostrud exercitation ullamco

Est lorem ipsum dolor sit amet, consectetur adipiscing elit, sed do eiusmod est tempor est incididunt ut labore et dolore.

Klora ipsum dolor sit amet, consectetur adipiscing elit, sed do eiusmod est tempor est incididunt.

See All Resources

Resources

Cross-pollinating resources on the About page in order to highlight this new content.

*Sonix Difference Teaser	*History Content Teaser	*News & Events Content Teaser
➤ See More	➤ Read More	➤ Read More

Products & Applications Catalog

Application & Products laboris nisi ut aliquip ex ea commodo consequat cupi datat non Sed ut perspiciatis unde omnis iste natus error sit voluptatem accusantium

Product or Application Imagery

Wafer Inspection Applications laboris nisi ut aliquip ex ea commodo consequat cupi datat non Sed ut perspiciatis unde omnis iste natus error sit voluptatem accusantium

Learn More

Product or Application Imagery

Wafer Inspection Products laboris nisi ut aliquip ex ea commodo consequat cupi datat non Sed ut perspiciatis unde omnis iste natus error sit voluptatem accusantium

Learn More

Product or Application Imagery

Semiconductor Package Inspection Applications laboris nisi ut aliquip ex ea commodo consequat cupi datat non Sed ut perspiciatis unde omnis iste natus error sit voluptatem accusantium

Learn More

Product or Application Imagery

Semiconductor Package Inspection Products nisi ut aliquip ex ea commodo consequat cupi datat non Sed ut perspiciatis unde omnis iste natus error sit voluptatem accusantium

Learn More

Product or Application Imagery

Industrial laboris nisi ut aliquip ex ea commodo consequat cupi datat non Sed ut perspiciatis unde omnis iste natus error sit voluptatem accusantium

Learn More

Product or Application Imagery

Industrial Application & Products laboris nisi ut aliquip ex ea commodo consequat cupi datat non Sed ut perspiciatis unde omnis iste natus error sit voluptatem

Learn More



*Sonix Difference Teaser

See More

*History Content Teaser

Read More

*News & Events Content Teaser

Read More

This category page is the entry point for the Sonix product catalog. End users will be able to select a product type (by card) which will link to the landing page template and then to the product details page.

The navigation, homepage, and search features will act as shortcuts if users choose to skip the category page.

Manual & Automated Wafer Inspection

Application & Productso laboris nisi ut aliquip ex ea commodo consequat cupi datat non Sed ut perspiciatis unde omnis iste natus error sit voluptatem accusantium

Historically, acoustic scanning microscopes were found primarily in back-end development and manufacturing of packaged semiconductors. Today, front-end manufacturers are also adopting nondestructive testing (NDT) as a wafer solution. Manufacturers are performing semiconductor wafer inspection and wafer metrology to help streamline product development, refine manufacturing processes, improve yield and ensure the long-term reliability of their products.

With automated wafer processing and wafer analysis features, AutoWafer is optimized for production-speed inspection of MEMS, TSV, LED, BSI and other bonded wafer technologies.

Wafer Inspection Applications

Applications explanation tation ullamco laboris nisi ut aliquip ex ea commodo consequat cupi datat non Sed ut perspiciatis unde omnis iste natus error svoluptatem accusantium.

Application Inspection Imagery

Bonded Wafers

At vero eos et accusamus et iusto odio dignissimos ducimus qui blanditiis praesentium voluptatum deleniti atque corrupti quos dolores et quas molestias excepturi sint occaecati cupiditate non provident, similique sunt in culpa qui officia deserunt mollitia animi, id est laborum et dolorum fuga. Et harum quidem rerum facilis est et expedita distinctio. Nam libero tempore, cum soluta nobis est eligendi

[Learn More](#)



Application Inspection Imagery

Microelectromechanical Systems - MEMS Inspection

At vero eos et accusamus et iusto odio dignissimos ducimus qui blanditiis praesentium voluptatum deleniti atque corrupti quos dolores et quas molestias excepturi sint occaecati cupiditate non provident, similique sunt in culpa qui officia deserunt mollitia animi, id est laborum et dolorum fuga. Et harum quidem rerum facilis est et expedita distinctio. Nam libero tempore, cum soluta nobis est eligendi

[Learn More](#)

Application Inspection Imagery

LED Inspection

At vero eos et accusamus et iusto odio dignissimos ducimus qui blanditiis praesentium voluptatum deleniti atque corrupti quos dolores et quas molestias excepturi sint occaecati cupiditate non provident, similique sunt in culpa qui officia deserunt mollitia animi, id est laborum et dolorum fuga. Et harum quidem rerum facilis est et expedita distinctio. Nam libero tempore, cum soluta nobis est eligendi

[Learn More](#)

Application Inspection Imagery

Through-Silicon Vias - TSV Inspection

At vero eos et accusamus et iusto odio dignissimos ducimus qui blanditiis praesentium voluptatum deleniti atque corrupti quos dolores et quas molestias excepturi sint occaecati cupiditate non provident, similique sunt in culpa qui officia deserunt mollitia animi, id est laborum et dolorum fuga. Et harum quidem rerum facilis est et expedita distinctio. Nam libero tempore, cum soluta nobis est eligendi

[Learn More](#)



Application Inspection Imagery

Backside Illuminated (BSI) Sensor Inspection

At vero eos et accusamus et iusto odio dignissimos ducimus qui blanditiis praesentium voluptatum deleniti atque corrupti quos dolores et quas molestias excepturi sint occaecati cupiditate non provident, similique sunt in culpa qui officia deserunt mollitia animi, id est laborum et dolorum fuga. Et harum quidem rerum facilis est et expedita distinctio. Nam libero tempore, cum soluta nobis est eligendi

[Learn More](#)

Industrial Application Inspection Imagery

Industrial Inspection

At vero eos et accusamus et iusto odio dignissimos ducimus qui blanditiis praesentium voluptatum deleniti atque corrupti quos dolores et quas molestias excepturi sint occaecati cupiditate non provident, similique sunt in culpa qui officia deserunt mollitia animi, id est laborum et dolorum fuga. Et harum quidem rerum facilis est et expedita distinctio. Nam libero tempore, cum soluta nobis est eligendi

[Learn More](#)

*Sonix Difference Teaser

[See More](#)

*History Content Teaser

[Read More](#)

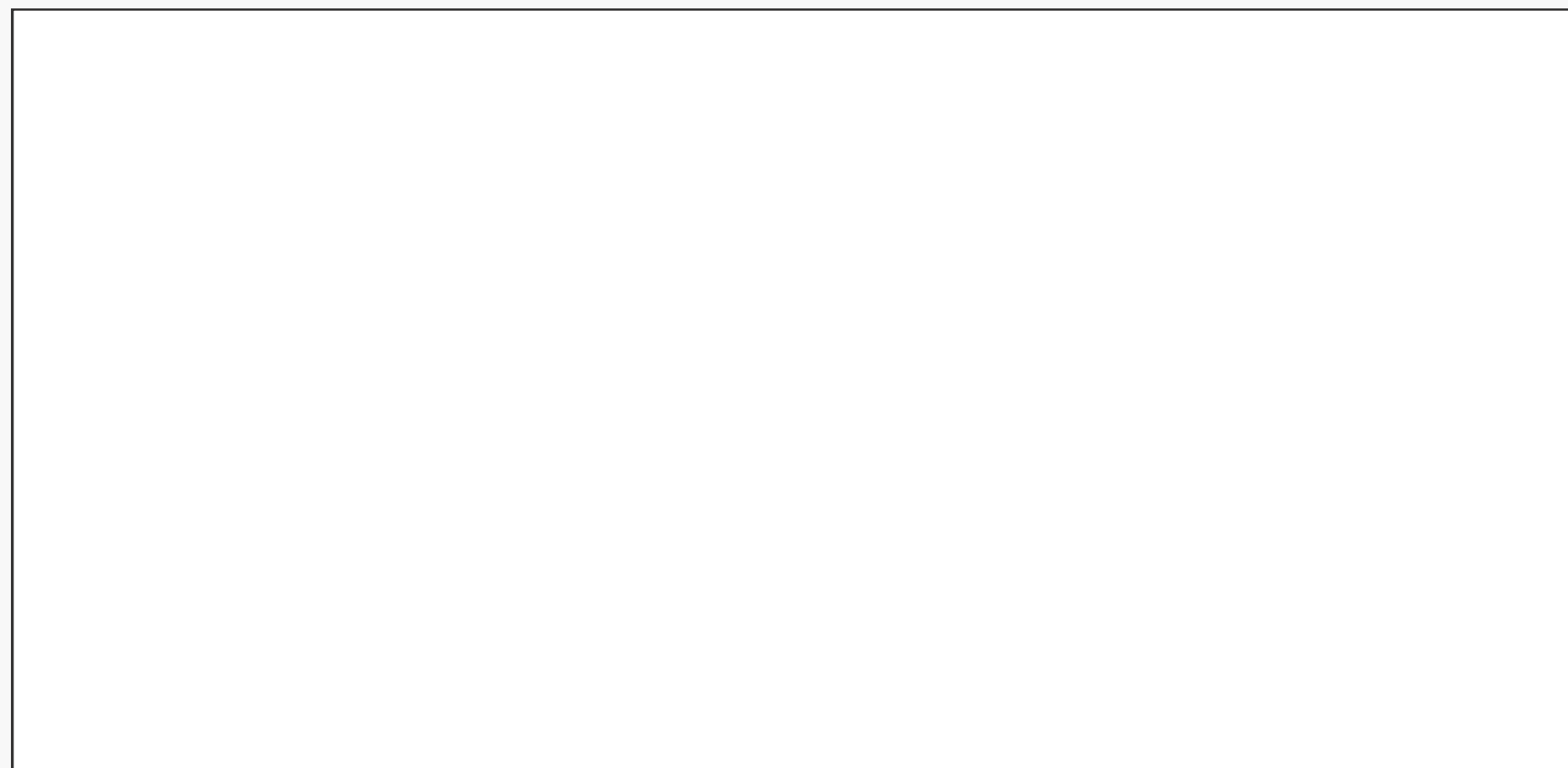
*News & Events Content Teaser

[Read More](#)

This is the category landing page template for products and applications. The hero area is reserved for introductory and discriptive content.

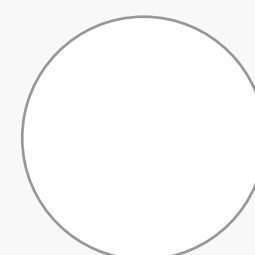
Finally, the individual stripes will link to the product details templates.

Echo Scanning Acoustic Microscope

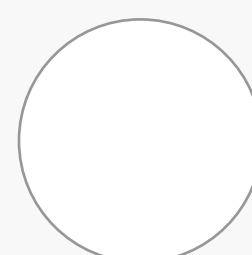


Overview

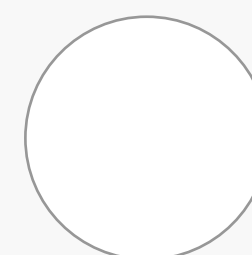
Sonix acoustic scanning microscopes are used by leading manufacturers worldwide to perform non-destructive inspection of bonded wafers and packaged semiconductors, in development, production, and failure analysis capacities.



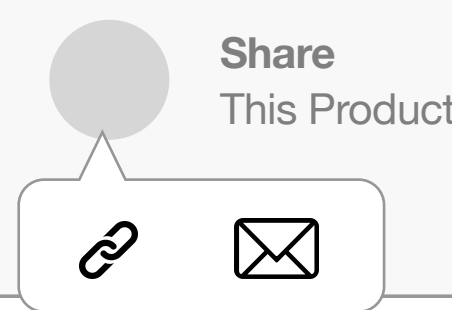
Specifications



Videos



Manuals



Detect, measure, and analyze sub-surface defects and features

Collect data at multiple sample depths in a single scan

Scan discrete devices, trays, strips, or wafers

Echo Scanning Acoustic Microscope

- Features
- Specifications
- Applications
- Software Options
- Other Features
- Support



Lorem ipsum dolor sit amet, consectetur adipiscing elit, sed do eiusmod tempor est incididunt ut labore et dolore magna aliqua. Ut enim ad minim veniam, quis nostrud exercitation ullamco laboris nisi ut aliquip ex ea commodo consequat.

- Duis aute irure dolor in reprehenderit in voluptate velit esse cillum dolore.

See How

Features

Basic System Specifications

Scan Area	350mm x 350mm active scan area
Size / Weight	78.7cm (w) x 78.7cm (d) x 121.4cm (h) / 240kg
Power	100-220VAC, 1PH/N/PE, 50/60 Hz
Water Supply	DI/RO/Tap 1 liter/min max, 70-700kPa (10-100PSI)
Water Drain	2 liter/min minimum
Certifications	SemiS2, CE, NRTL, TUV

Specifications Table

Supporting Imagery/Statistics

Supporting Imagery/Statistics

Supporting Imagery/Statistics

Lorem ipsum dolor sit amet, consectetur adipiscing elit, sed do eiusmod tempor est incididunt ut labore et dolore magna aliqua. Ut enim ad minim veniam, quis nostrud exercitation ullamco

Est lorem ipsum dolor sit amet, consectetur adipiscing elit, sed do eiusmod tempor est incididunt ut labore et dolore magna aliqua. Ut enim ad minim veniam, quis nostrud exercitation ullamco

Klora ipsum dolor sit amet, consectetur adipiscing elit, sed do eiusmod tempor est incididunt ut labore et dolore magna aliqua. Ut enim ad minim veniam, quis nostrud exercitation ullamco

Applications

Lorem ipsum dolor sit amet, consectetur adipiscing elit, sed do eiusmod tempor est incididunt ut labore et dolore magna aliqua. Ut enim ad minim veniam, quis nostrud exercitation ullamco laboris nisi ut aliquip ex ea commodo consequat. Incididunt ut labore et dolore magna aliqua. Ut enim ad minim veniam, quis est.

Software Related Imagery

Software Options

Product Image

Lorem ipsum dolor sit amet, consectetur adipiscing elit, sed do eiusmod tempor est incididunt ut labore et dolore magna aliqua. Ut enim ad minim veniam.

- Aute irure dolor in reprehenderit in voluptate velit esse cillum dolore.
- Duis aute irure dolor in reprehenderit in voluptate velit esse cillum dolore.

See How

Other features



Lorem ipsum dolor sit amet, consectetur adipiscing elit, sed do eiusmod tempor est incididunt ut labore et dolore magna aliqua. Ut enim ad minim veniam, quis nostrud exercitation ullamco laboris nisi ut aliquip ex ea commodo consequat.

- Duis aute irure dolor in reprehenderit in voluptate velit esse cillum dolore.

See More

Support

Related Products

Product Imagery

Product Imagery

Product Imagery

Related Products

Request a Sample Analysis

Custom Quote Imagery

Lorem ipsum dolor sit amet, consectetur adipiscing elit, sed do eiusmod tempor est incididunt ut labore et dolore magna aliqua. Ut enim ad minim veniam, quis nostrud exercitation ullamco laboris nisi ut aliquip.

Request a Sample Analysis

Request a Sample Analysis CTA

*Sonix Difference Teaser

See More

*History Content Teaser

Read More

*News & Events Content Teaser

Read More

Contact Us

[Request A Quote](#)[Support](#)[Request A Sample Analysis](#)

Considering a Sonix solution to improve your failure analysis and production inspection capabilities? Complete this form and we will have a local representative contact you to learn more about your application and provide a solution proposal that meets your requirement.

* Required Field

First Name*

Last Name*

Email Address*

Confirm Email Address*

Company*

Job Title*

Telephone*

Where are you located?

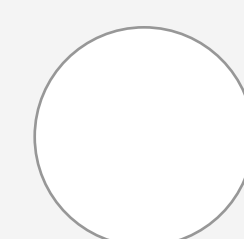
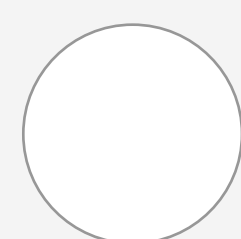
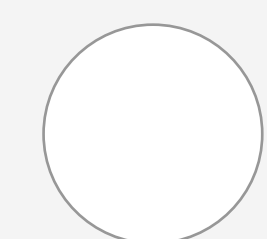
Your Question*

1000 characters remaining

The goal with the tabbed contact form is to allow end-users to select a specific subject matter ahead of completing the form. For example, a user may want to send an attachment or include a return address.

The support form will have an additional file upload input field allowing users to select multiple files to upload. The maximum upload size is TBD.

The request for a sample analysis form will include all of the existing support input fields and a products and applications pull-down menu, allowing users to select the pertinent product or application.



Clicking on the globe icon will reveal a country pulldown menu

Select a country

The header should carry forward imagery and friendly messaging from the global footer CTA.

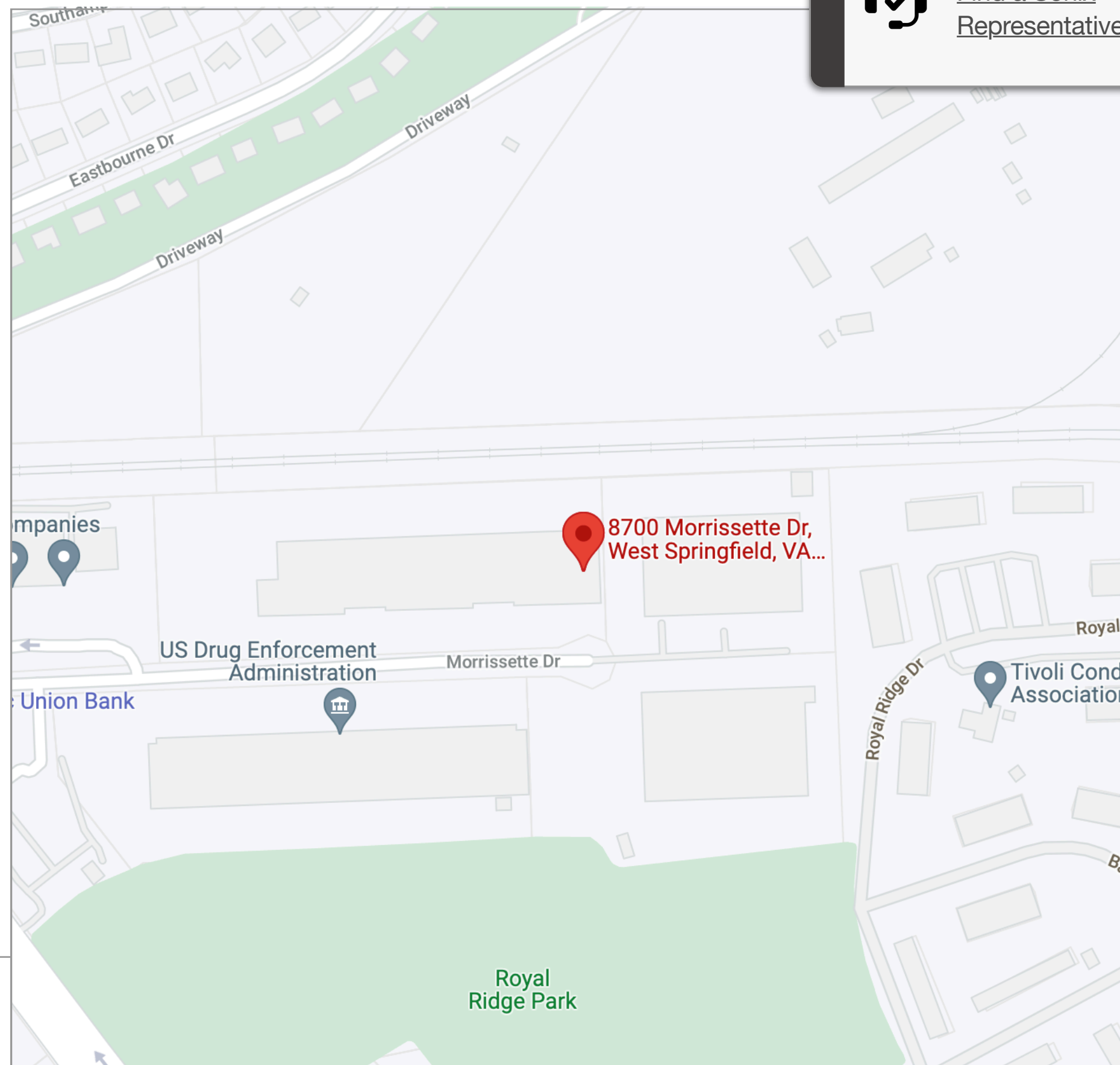
CONNECT WITH US

- Request a Quote
- Contact Us
- Find a Sonix Representative

Sonix Corporate Offices

Sonix Headquarters
8700 Morrissette Drive
Springfield, VA 22152

T: 703.440.0222
F: 703.440.9512
Email us: info@sonix.com



Sonix Offices

Please select a country

Select a country

This will trigger the same overlay as the globe icon in the global header providing hyperlinked Sonix websites and offices by country. For example, if the user selects the Asia region, the associated results will appear in the overlay.

- South East Asia
- China (mainland)
- France
- Germany
- Greece
- Hong Kong
- India
- Israel
- Italy
- Korea
- Malta
- Morocco
- Philippines
- Portugal
- Singapore
- Spain
- Switzerland (french)
- Taiwan
- Thailand
- United States

Connect with Us

Lorem ipsum dolor sit amet, est... consectetur adipiscing elit. Namin hendrerit nisi sed sollicitudin pellentesque.

* Required Field

Select an option *

Request a quote

First Name*

First Name

Last Name*

Last Name

Email Address*

Email Address

Confirm Email Address*

Confirm Email Address

Company*

Email Address

Job Title*

Confirm Email Address

Telephone*

Country Prefix Phone

Where are you located?

United States

Your Question*

Text area for user question

1000 characters remaining

Opt in for in for updates, newsletters, promotions (uncheck to unsubscribe).

Cancel

Submit Form

The Reason for connecting pulldown menu will list the following options:

1. Request a quote
2. Request a sample analysis
3. Support

Based on the selection, the form fields may change. Exact form fields will be repurposed from the legacy site, unless otherwise noted.

TBD on form fields Request a sample analysis & Support forms

*Sonix Difference Teaser

See More

*History Content Teaser

Read More

*News & Events Content Teaser

Read More



Change locations & find a local sales office

Sonix Corporate Offices

Sonix Headquarters
8700 Morrisette Drive
Springfield, VA 22152

www.sonix.com



← Clicking the close button on the overlay will /' cause the overlay to close and the user remains on the Contact Us page.

Conversely, if they access the overlay from any page through the Global Header, they will remain on the page that they accessed it from.

- Request a Quote
- Contact Us
- Find a Sonix Representative

← By default, the overlay should always feature the site that the user is currently on. For example, the user is currently on the corporate site.

Asia

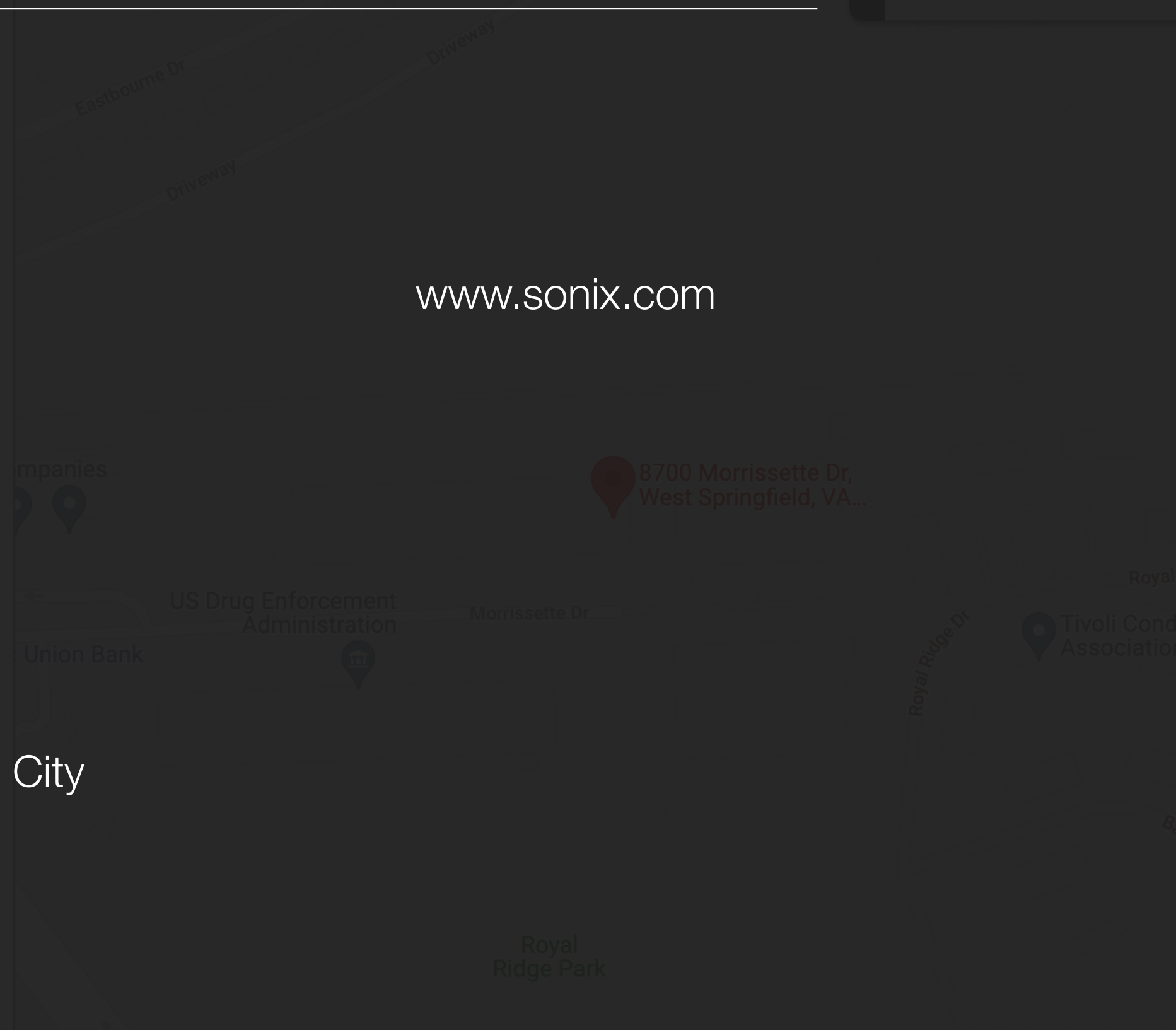
Sonix South East Asia

BH Lee - Taiwan and SEA Sales Manager
T: +886-3-6579181
M: +886-975-693597
bh.lee@sonix.com
Email us: info@sonix.com

www.sonix.com

Sonix Philippines

Technology Edge, Inc.
#50 H. Truman Drive
Parkwood Greens, Maybunga, 1607 Pasig City
Philippines
T: 632.628.4695 / 632.642.4501
sales@technologyedgeinc.com
service@technologyedgeinc.com



Sonix Korea

Jeshin Lee (JS)
601, 18-3 Korean Scout Bldg
Yeouido-Dong, Yeongdungpo-Gu
Seoul, Korea
T: +82.2.785.4747
F: +82.2.785.4848
js.lee@sonix.com

www.sonix.com

Reason for Connecting*
Request a Quote

First Name*

Last Name*

Below, the selected region and associated entries appear based on what the user selected. Again, if the user selected Asia, all contacts, offices, and websites within the region should display.